

Annex B.ii. Photograph: EUT Internal Photo

Cover Off - Top View 1

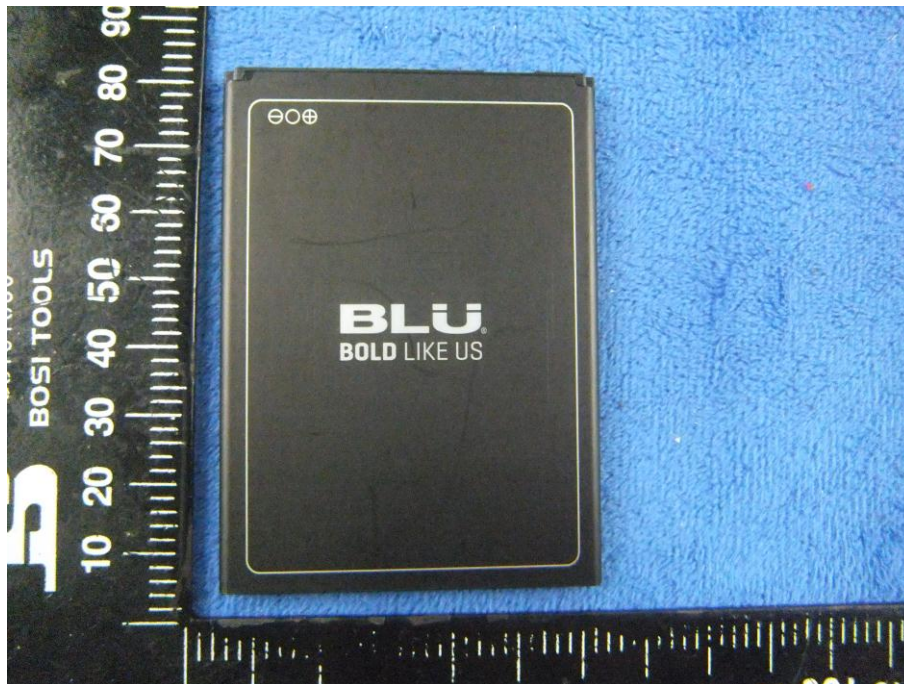


Cover Off - Top View 2



Test Report	17070456-FCC-E
Page	26 of 36

Battery - Front View



Battery - Rear View



A photograph of a disassembled smartphone showing the internal components. The components are laid out on a blue textured surface. A black ruler is visible on the left side, with markings from 10 to 50. The internal components include a green printed circuit board (PCB) with various electronic components, a silver SIM card slot, a black battery, and a black plastic housing. The PCB has several labels, including "AS02B1", "AP05R 6", "2201707011002", "A501-V03-M", and "1500". The battery is a large, rectangular, black component. The plastic housing is a black, L-shaped component. The components are arranged in a way that shows the internal layout of the phone.

The image shows a MediaTek MT6570 mobile phone motherboard. The board is green and populated with various components. A large white heat shield covers the central processing unit (SoC). The SoC is labeled "MEDIATEK MT6570". Other visible components include RAM modules, a camera module, and various passive components like capacitors and resistors. A black ruler is placed vertically on the left side of the board for scale, showing measurements in centimeters (10, 20, 30, 40, 50).

Mainboard without Shielding – Front View



Mainboard without Shielding – Rear View



LCD – Front View



LCD – Rear View



GSM/PCS/UMTS-FDD - Antenna View



WIFI/BT/BLE/GPS - Antenna View

